ON Semiconductor

Is Now

Onsemi

To learn more about onsemi[™], please visit our website at <u>www.onsemi.com</u>

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product factures, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and asfety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or by customer's technical experts. onsemi products and actal performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application, Buyer shall indemnify and hold onsemi and its officers, employees, subsidiari



Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese



FSB137HL Green-Mode Fairchild Power Switch (FPS™)

Features

mWSaver™ Technology

- Achieves Low No-Load Power Consumption: < 40 mW at 230 V_{AC} (EMI Filter Loss Included)
- Meets 2013 ErP Standby Power Regulation (< 0.5 W Consumption with 0.25 W Load) for ATX Power and LCD TV Power
- Eliminates X-Cap Discharge Resistor Loss with AX-CAP[®] Technology
- Operates at Linearly Decreased Switching Frequency at Light-Load Condition; in Advanced Burst Mode Operation at No-Load Condition
- 700 V High-Voltage JFET Startup Circuit Eliminates Startup Resistor Loss

Highly Integrated with Rich Features

- Internal Avalanche-Rugged 700 V SenseFET
- Built-in 5 ms Soft-Start
- Peak-Current-Mode Control
- Cycle-by-Cycle Current Limiting
- Leading-Edge Blanking (LEB)
- Synchronized Slope Compensation
- Proprietary Asynchronous Jitter to Reduce EMI

Advanced Protection

- Internal Overload / Open-Loop Protection (OLP)
- V_{DD} Under-Voltage Lockout (UVLO)
- V_{DD} Over-Voltage Protection (OVP)
- Constant Power Limit (Full AC Input Range)
- Internal Latch Protection (OLP, V_{DD} OVP, OTP)
- Internal OTP Sensor with Hysteresis

Description

The FSB137HL is a next-generation, Green-Mode, Fairchild Power Switch (FPS[™]) that incorporates Fairchild's innovative mWSaver[™] technology, which dramatically reduces standby and no-load power consumption, enabling conformance to all worldwide Standby Mode efficiency guidelines. It integrates an advanced current-mode pulse width modulator (PWM) and an avalanche-rugged 700 V SenseFET in a single package, allowing auxiliary power designs with higher standby efficiency, reduced size, improved reliability, and lower system cost than prior solutions.

Fairchild Semiconductor's mWSaver™ technology offers best-in-class minimum no-load and light-load power consumption. An innovative Ax-CAP[®] method, one of the five proprietary mWSaver™ technologies, minimizes losses in the EMI filter stage by eliminating the X-cap discharge resistors while meeting IEC61010-1 safety requirements. mWSaver™ Green Mode gradually decreases switching frequency as load decreases to minimize switching losses.

Proprietary asynchronous jitter decreases EMI emission and built-in synchronized slope compensation allows stable peak-current-mode control over a wide range of input voltage. The proprietary internal line compensation ensures constant output power limit over the entire universal line voltage range.

Requiring a minimum number of external components, FSB137HL provides a basic platform that is well suited for the cost-effective flyback converter design with low standby power consumption.

Applications

General-purpose switched-mode power supplies (SMPS) and flyback power converters, including:

- Auxiliary Power Supply for PC, Server, LCD TV, and Game Console
- SMPS for VCR, SVR, STB, DVD, and DVCD Player, Printer, Facsimile, and Scanner
- General Adapter
- LCD Monitor Power / Open-Frame SMPS

Ordering Information

	Part Number	SenseFET	Operating Temperature Range	Package	Packing Method
l	FSB137HLN	3 A / 700 V	-40°C to +105°C	8-Pin, Dual In-Line Package (DIP)	Tube

Application Diagram



Figure 1. Typical Flyback Application

Output Power Table⁽¹⁾

Product	230 V _{AC}	± 15% ⁽²⁾	85-265 V _{AC}	
Froduct	Adapter ⁽³⁾	Open Frame ⁽⁴⁾	Adapter ⁽³⁾	Open Frame ⁽⁴⁾
FSB137HLN	17.5 W	25 W	13 W	19 W

Notes:

1. The maximum output power can be limited by junction temperature.

2. 230 V_{AC} or 100 / 115 V_{AC} with voltage doublers.

3. Typical continuous power in a non-ventilated enclosed adapter with sufficient drain pattern of printed circuit board (PCB) as a heat sink, at 50°C ambient.

4. Maximum practical continuous power in an open-frame design with sufficient drain pattern of printed circuit board (PCB) as a heat sink, at 50°C ambient.



Block Diagram

© 2013 Fairchild Semiconductor Corporation FSB137HL • Rev. 2, Feb-2020

Pin Configuration



<i>F</i> – Fairchild Logo
Z – Plant Code
X – 1-Digit Year Code
Y – 1-Digit Week Code
TT – 2-Digit Die Run Code
T – Package Type (N: DIP)
M – Manufacture Flow Code



Pin Definitions

Pin #	Name	Description	
1	GND	Ground . This pin internally connects to the SenseFET source and signal ground of the PWM controller.	
2	VDD	Supply Voltage of the IC . The holdup capacitor typically connects from this pin to ground. A rectifier diode in series with the transformer auxiliary winding connects to this pin to supply bias during normal operation.	
3	FB	Feedback . The signal from the external compensation circuit connects to this pin. The PWI cycle is determined by comparing the signal on this pin and the internal current-sense signal	
4 LH Latch. This pin is utilized for application.		Latch. This pin is utilized for pull-HIGH latch protection by the external circuit, depending on the application.	
5	HV	Startup . Typically, resistors in series with diodes from the AC line connect to this pin to supply internal bias and to charge the external capacitor connected between the VDD pin and the GND pin during startup. This pin is also used to sense the line voltage for brown-in and to detect AC line disconnection.	
6			
7	Drain	SenseFET Drain. This pin is designed to directly drive the transformer.	
8			

FSB137HL — Green Mode Fairchild Power Switch (FPS™)

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Param	eter	Min.	Max.	Unit
V _{DRAIN}	Drain Pin Voltage ^(5,6)			700	V
I _{DM}	Drain Current Pulsed ⁽⁷⁾			12	А
E _{AS}	Single-Pulsed Avalanche Energy ⁽⁸⁾			230	mJ
V _{DD}	DC Supply Voltage			30	V
V _{FB}	FB Pin Input DC Voltage		-0.3	5.5	V
V _{LH}	LH Pin Input DC Voltage		-0.3	5.5	V
V _{HV}	HV Pin Input DC Voltage			700	V
PD	Power Dissipation (T _A <50°C)			1.55	W
TJ	Operating Junction Temperature		-40	Internally Limited ⁽⁹⁾	°C
T _{STG}	Storage Temperature Range		-55	+150	°C
TL	Lead Soldering Temperature (Wave	Soldering or IR, 10 Seconds)		+260	°C
	Electrostatic Discharge Capability,	Human Body Model: JESD22-A114	7.0		
500	All Pins Except HV Pin	Charged Device Model: JESD22-C101	2.0		
ESD	Electrostatic Discharge Capability,	Human Body Model: JESD22-A114	4.5		- kV
	All Pins Including HV Pin	Charged Device Model: JESD22-C101	1.5		

Notes:

5. All voltage values, except differential voltages, are given with respect to the network ground terminal.

6. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.

7. Repetitive rating: pulse width is limited by maximum junction temperature.

8. L = 51 mH, starting $T_J = 25^{\circ}C$.

9. Internally limited by Over-Temperature Protection (OTP), refer to T_{OTP}.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
R _{HV}	Resistor Connected to HV Pin for Full Range Input Detection	150	250	kΩ

Thermal Resistance Table

Symbol	Parameter	Тур.	Unit
θ _{JA}	Junction-to-Air Thermal Resistance	81	°C/W
Ψյτ	Junction-to-Package Thermal Resistance ⁽¹⁰⁾	25	°C/W

Note:

10. Measured on the package top surface.

FSB137HL — Green Mode Fairchild Power Switch (FPS™)

Electrical Characteristics

 $V_{\text{DD}}\text{=}15$ V and $T_{\text{A}}\text{=}25^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
SenseFET	Section ⁽¹¹⁾	l			1	
BV _{DSS}	Drain-Source Breakdown Voltage	$\label{eq:VGS} \begin{array}{l} V_{GS}=0 \ V, \ I_{D}=250 \ \mu A, \\ T_{J}=25^{\circ}C \end{array}$	700			V
		$V_{DS} = 700 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			50	
I _{DSS}	Zero-Gate-Voltage Drain Current	$V_{DS} = 560 \text{ V}, V_{GS} = 0 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$			200	μA
R _{DS(ON)}	Drain-Source On-State Resistance ⁽¹²⁾	$V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}$		4.00	4.75	Ω
C _{ISS}	Input Capacitance	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ V_{DS} = 25 \ V, \\ f = 1 \ MHz \end{array}$		315	410	pF
C _{OSS}	Output Capacitance	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ V_{DS} = 25 \ V, \\ f = 1 \ MHz \end{array}$		47	61	pF
C _{RSS}	Reverse Transfer Capacitance	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \ V_{DS} = 25 \ V, \\ f = 1 \ MHz \end{array}$		9.0	24.0	pF
t _{d(on)}	Turn-On Delay	$V_{DS} = 350 \text{ V}, \text{ I}_{D} = 1.0 \text{ A}$		11.2	33.0	ns
tr	Rise Time	$V_{DS} = 350 \text{ V}, \text{ I}_{D} = 1.0 \text{ A}$		34	78	ns
t _{d(off)}	Turn-Off Delay	$V_{DS} = 350 \text{ V}, \text{ I}_{D} = 1.0 \text{ A}$		28.2	67.0	ns
t _f	Fall Time	$V_{DS} = 350 \text{ V}, I_D = 1.0 \text{ A}$		32	74	ns
Control Se	ection					
VDD Secti	ion					
V _{DD-ON}	UVLO Start Threshold Voltage		11	12	13	V
V _{DD-OFF1}	UVLO Stop Threshold Voltage		5	6	7	V
$V_{\text{DD-OFF2}}$	Threshold Voltage of VDD Pin for HV Device Turn-On at Latch Mode		8	9	10	V
$V_{\text{DD-LH}}$	Threshold Voltage on VDD Pin for Latch-Off Release Voltage		3.5	4.0	4.5	V
I _{DD-ST}	Startup Supply Current	V _{DD-ON} – 0.16 V			30	μA
I _{DD-OP1}	Operating Supply Current with Normal Switching Operation	V_{DD} = 15 V, V_{FB} = 3 V			3.6	mA
I _{DD-OP2}	Operating Supply Current without Switching Operation	$V_{DD} = 15 \text{ V}, \text{ V}_{FB} = 1 \text{ V}$			1.6	mA
V _{DD-OVP}	V _{DD} Over-Voltage Protection ⁽¹¹⁾			28		V
t _{D-VDDOVP}	V _{DD} Over-Voltage Protection Debounce Time ⁽¹¹⁾			150		μs
HV Sectio	n					
I _{HV}	Supply Current Drawn from HV Pin	$ \begin{array}{l} HV = 120 \ V_{DC}, \\ V_{DD} = 0 \ V \ \text{with} \ 10 \ \mu\text{F} \end{array} $	1.5		5.0	mA
I _{HV-LC}	Leakage Current after Startup	$ HV = 700 V, \\ V_{DD} = V_{DD-OFF1} + 1 V $			10	μA
V _{AC-ON}	Brown-in Threshold Level (V_{DC})	DC Voltage Applied to HV Pin through 200 k Ω	102	110	118	V
KDISCHARGE	X-Cap Discharge Threshold	R = 200 k Ω to HV Pin	60			%
t _{AC-OFF}	AC-Off Debounce Time for HV Discharge Function ⁽¹¹⁾			160		ms

Continued on the following page...

FSB137HL -
Green Mod
le Fairchild F
^D ower Swit
tch (FPS™)

Electrical Characteristics

 $V_{DD}{=}15$ V and $T_{A}{=}25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Oscillator S	Section		I	11		
4	Fraguency in Naminal Made	Center Frequency	94	100	106	レ니ㅋ
f _{OSC}	Frequency in Nominal Mode	Hopping Range	±4.0	±6.0	±8.0	kHz
t _{HOP}	Hopping Period ⁽¹¹⁾			20		ms
f _{OSC-G}	Green-Mode Frequency		20	23	26	kHz
DCY_{MAX}	Maximum Duty Cycle		80			%
f _{DV}	Frequency Variation vs. V_{DD} Deviation	V_{DD} = 11 V to 22 V			5	%
f _{DT}	Frequency Variation vs. Temperature Deviation ⁽¹¹⁾	T _A = -40 to 105°C			5	%
Feedback I	nput Section					
Av	Internal Voltage Dividing Factor of FB Pin ⁽¹¹⁾		1/4.5	1/4.0	1/3.5	V/V
Z _{FB}	Pull-Up Impedance of FB Pin		24	29	34	kΩ
V_{FB} -Open	FB Pin Pull-Up Voltage	FB Pin Open	5.2	5.4	5.5	V
$V_{\text{FB-OLP}}$	FB Voltage Threshold to Trigger Open- Loop Protection		4.3	4.6	4.9	V
t _{D-OLP}	Delay of FB Pin Open-Loop Protection		46	56	66	ms
$V_{\text{FB-N}}$	FB Voltage Threshold to Exit Green Mode	V _{FB} Rising	2.4	2.6	2.8	V
$V_{\text{FB-G}}$	FB Voltage Threshold to Enter Green Mode	V _{FB} Falling		V _{FB-N} - 0.1		V
$V_{\text{FB-ZDC}}$	FB Voltage Threshold to Enter Zero- Duty State	V _{FB} Falling	2.0	2.1	2.2	V
V _{FB-ZDCR}	FB Voltage Threshold to Exit Zero- Duty State	V _{FB} Rising		V _{FB-ZDC} + 0.1		V
LH Pin Sec	tion					
VLATCH	Latch Comparator Reference Voltage		4.1	4.4	4.7	V
t _{LATCH}	Latch Mode Debounce Time				35	μs
V _{LH-OPEN}	LH Pin Open Voltage		3.0	3.5	4.0	V
Current-Se	nse Section ⁽¹³⁾					•
I _{LMT-FL}	Flat Threshold Level of Current Limit	Duty>40%	0.85	1.00	1.15	Α
I _{LMT-VA}	Valley Threshold Level of Current Limit ⁽¹¹⁾	Duty=0%		I _{LMT-FL} - 0.2		Α
t _{PD}	Current Limit Turn-Off Delay			100	200	ns
t _{LEB}	Leading-Edge Blanking Time		230	280	330	ns
tss	Soft-Start Time ⁽¹¹⁾			5		ms
Over-Temp	erature Protection Section (OTP)					
T _{OTP}	Junction Temperature Trigger OTP ^(11,14)			135		°C
ΔT_{OTP}	Hysteresis of OTP ^(11,15)			T _{OTP} -25		°C

Notes:

11. Guaranteed by design; not 100% tested in production.

12. Pulse test: pulse width \leq 300 µs, duty \leq 2%.

13. These parameters, although guaranteed, are tested in wafer-sort process.

14. When activated, the output is disabled and enters latch protection.

15. The threshold temperature for enabling the output again and resetting the latch after over-temperature protection has been activated.



Figure 8. V_{AC-ON} vs. Temperature

Figure 9. V_{LATCH} vs. Temperature



Figure 10. t_{LATCH} vs. Temperature







Figure 13. V_{FB-N} - V_{FB-G} vs. Temperature

0

25

Temperature (°C)

50

75

85

100

125



Figure 14. V_{FB-ZDC} vs. Temperature

Figure 15. I_{LMT-FL} vs. Temperature

FSB137HL — Green Mode Fairchild Power Switch (FPS™)

Functional Description

Startup Operation

The HV pin is typically connected to the AC line input through two external diodes and one resistor (R_{HV}), as shown in Figure 16. When the AC line voltage is applied, the V_{DD} hold-up capacitor is charged by the line voltage through the diodes and resistor. After V_{DD} voltage reaches the turn-on threshold voltage (V_{DD-ON}), the startup circuit charging the V_{DD} capacitor is switched off and V_{DD} is supplied by the auxiliary winding of the transformer. Once the FSB137HL starts, it continues operation until V_{DD} drops below 6 V ($V_{DD-OFF1}$). The IC startup time with a given AC line input voltage is:





Figure 16. Startup Circuit

Brown-in Function

The HV pin can detect the AC line voltage using a switched voltage divider that consists of external resistor (R_{HV}) and internal resistor (R_{LS}), as shown in Figure 16. The internal line-sensing circuit detects the real RMS value of the line voltage using a sampling circuit and peak-detection circuit. Because the voltage divider causes power consumption when it is switched on, the switching is driven by a signal with a very narrow pulse width to minimize power loss. The sampling frequency is adaptively changed according to the load condition.

Based on the detected line voltage, the brown-in threshold is determined. Since the internal resistor (R_{LS}) of the voltage divider is much smaller than R_{HV} , the thresholds are given as:

$$V_{BROWN-IN}(RMS) = \frac{R_{HV}}{200k} \cdot \frac{V_{AC-ON}}{\sqrt{2}}$$
(2)

PWM Control

The FSB137HL employs current-mode control, as shown in Figure 17. An opto-coupler (such as the H11A817A) and shunt regulator (such as the KA431) are typically used to implement the feedback network. Comparing the feedback voltage with the voltage across the R_{SENSE} resistor makes it possible to control the switching duty cycle. A synchronized positive slope is

added to the SenseFET current information to ensure stable current-mode control over a wide range of input voltage. The built-in slope compensation stabilizes the current loop and prevents sub-harmonic oscillation.



Figure 17. Current Mode Control

Soft-Start

The internal soft-start circuit progressively increases the pulse-by-pulse current-limit level of the MOSFET during startup to establish the correct working conditions for transformers and capacitors, as shown in Figure 18. The current limit levels have nine steps, as shown in Figure 19. This prevents transformer saturation and reduces stress on the secondary diode during startup.







Figure 19. Current Limit Variation During Soft-Start

HIGH / LOW Line Compensation for Constant Power Limit

To maintain constant limited output power, regardless of the line voltage condition, a special current-limit profile with sample-and-hold is used (as shown in Figure 20). The current-limit level is sampled and held at the falling edge of the gate drive signal, as shown in Figure 21. Then the sampled current-limit level is used for the next switching cycle. The sample-and-hold function prevents sub-harmonic oscillation in current-mode control.

The current-limit level increases as the duty cycle increases, which reduces the current limit as duty cycle decreases. This allows a lower current-limit level for high-line voltage condition where the duty cycle is smaller than that of low line. Therefore, the limited maximum output power can remain constant even for a wide input voltage range.







Figure 21. Current Limit Variation with Duty Cycle

mWSaver™ Technology

AX-CAP[®] Elimination of X-Cap Discharge Resistors

The EMI filter in the front end of the switched-mode power supply (SMPS) typically includes a capacitor across the AC line connector, as shown in Figure 22. Most of the safety regulations, such as UL1950 and IEC61010-1, require the capacitor be discharged to a safe level within a given time after being unplugged from the power outlet. Typically, a discharge resistor across the capacitor is used to ensure the capacitor is discharged naturally, which introduces power loss. As power level increases, the EMI filter capacitor tends to increase, requiring a smaller discharge resistor to maintain the same discharge time. This typically results in more power dissipation in high-power applications. The innovative AX-CAP technology intelligently discharges the filter capacitor only when the power supply is unplugged from the power outlet. Since the AX-CAP® discharge circuit is disabled during normal operation, the power loss in the EMI filter can be virtually removed.



Figure 22. AX-CAP[®] Circuit

Green Mode

The FSB137HL modulates the PWM frequency as a function of FB voltage, as shown in Figure 23. Since the output power is proportional to the FB voltage in current-mode control, the switching frequency decreases as load decreases. In heavy-load conditions, the switching frequency is 100 kHz. Once V_{FB} decreases below V_{FB-N} (2.6 V), the PWM frequency linearly decreases from 100 kHz to 23 kHz to reduce switching losses at light-load condition. As V_{FB} decreases to V_{FB-G} (2.5 V), the switching frequency is fixed at 23 kHz.

As V_{FB} falls below V_{FB-ZDC} (2.1 V), the FSB137HL enters Burst Mode, where PWM switching is disabled. Then the output voltage starts to drop, causing the feedback voltage to rise. Once V_{FB} rises above $V_{FB-ZDCR}$, switching resumes. Burst Mode alternately enables and disables switching, reducing switching loss to reduce power consumption, as shown in Figure 24.



Protections

Protection functions include Overload / Open-Loop Protection (OLP), Over-Voltage Protection (OVP), and Over-Temperature Protection (OTP). All the protections are implemented as Latch Mode. Once the fault condition is detected, switching is terminated and the SenseFET remains off. This causes V_{DD} to fall and "hiccup" between 9 V and 12 V. As long as AC input is unplugged; V_{DD} falls to 4 V, the latch can be released, and the HV startup circuit charges V_{DD} up to 12 V voltage; allowing restart.

Open-Loop / Overload Protection (OLP)

Because of the pulse-by-pulse current-limit capability, the maximum peak current through the SenseFET is limited and maximum input power is limited. If the output consumes more than the limited maximum power, the output voltage (V_0) drops below the set voltage. Then the current through the opto-coupler LED and the transistor become virtually zero and FB voltage is pulled HIGH, as shown in Figure 25. If feedback voltage is above 4.6 V for longer than 56 ms, OLP is triggered.

This protection is also triggered when the feedback loop is open due to a soldering defect.



V_{DD} Over-Voltage Protection (OVP)

If the secondary-side feedback circuit malfunctions or a solder defect causes an opening in the feedback path, the current through the opto-coupler transistor becomes virtually zero. Then feedback voltage climbs up in a similar manner to the overload situation, forcing the preset maximum current to be supplied to the SMPS until the overload protection triggers. Because more energy than required is provided to the output, the output voltage may exceed the rated voltage before the overload protection triggers, resulting in the breakdown of the devices in the secondary side. To prevent this situation, an OVP circuit is employed. Since V_{DD} voltage is proportional to the output voltage by the transformer coupling, the over voltage of output is indirectly detected using V_{DD} voltage. The OVP is triggered when V_{DD} voltage reaches 28 V. Debounce time (typically 150 µs) is applied to prevent false triggering by switching noise.

Over-Temperature Protection (OTP)

The SenseFET and the control IC are integrated in one package. This makes it easier for the control IC to detect the abnormal over temperature of the SenseFET. If the temperature exceeds approximately 135°C, the OTP is triggered and the MOSFET remains off.



A) THIS PACKAGE CONFORMS TO JEDEC MS-001 VARIATION BA WHICH DEFINES 2 VERSIONS OF THE PACKAGE TERMINAL STYLE WHICH ARE SHOWN HERE.

- **B) CONTROLING DIMS ARE IN INCHES**
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D) DIMENSION S AND TOLERANCES PER ASME Y14.5M-2009
- E) DRAWING FILENAME AND REVSION: MKT-N08MREV2.



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor date sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use a a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor houteds for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

ON Semiconductor Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada Phone: 011 421 33 790 2910 Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative